

MAINTENANCE MANUAL

29. 7-50 MHz, 50-WATT POWER AMPLIFIER BOARD 19D423356GI-G6

TABLE OF CONTENTS	
DESCRIPTION page	1
CIRCUIT ANALYSIS page	1
OUTLINE DIAGRAM page	1
SCHEMATIC DIAGRAM page 5	5
PARTS LIST AND PRODUCTION CHANGES	3

DESCRIPTION

The 29.7-50 MHz PA assembly for MASTR® Executive II uses three RF power transistors to provide a power output of 50 Watts. The output power is adjustable using power adjust control R14 over a range of 15 to 50 Watts. A single transistor is used in the power adjust circuit.

Supply voltage for the PA is connected through power leads from the system-audio-squelch board (SAS) to feed through capacitors C297 and C298 on the side of the PA assembly. C297, C298, C299, L295 and L296 prevent RF from getting on the power leads. Diode CR295 will cause the main fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the radio.

The PA assembly is insulated from vehicle ground to permit operation in positive or negative ground vehicles.

- NOTE ·

In positive ground vehicles, Ais "hot" with respect to vehicle
ground. Shorting the transmitter
PA printed wiring board ground
pattern to the radio case may
cause one of the in-line fuses
to blow.

The hinged PA heat sink pivots 90° to provide access to the power amplifier board, low pass filter and centralized metering jack J205.

Centralized metering jack J205 is provided for use with GE Test Set Model 4EX3All or Test Kit 4EX8K12. The Test Set meters the Ampl-1 drive (exciter output), Ampl-1 (collector), driver current and PA current.

CIRCUIT ANALYSIS

RF AMPLIFIERS

The exciter output is coupled through cable W216 to PA input jack J201. The RF is coupled through DC blocking capacitor C1 and an impedance matching network to the base of Class C amplifier Q201. The network matches the 50-ohm input to the base of Q201, and consists of C6, C7, C8, L1 and L2. L3 and R1 comprise a stabilizing network in the base circuit of Q201.

Part of the RF input is rectified by CR1 and applied to voltage divider R2 and R3. This voltage is used to meter the AMPL-1 drive at J205.

Collector voltage to Q201 (Ampl-1) is controlled by the power adjust circuit, Q204 and is applied through collector stabilizing network (L15 and R7) and collector feed network L4 and C9. The collector voltage of Q201 is metered through R11 at J205.

The output of Q201 is coupled to the base of Class C driver Q202 through coupling capacitor C10, a matching network consisting of L5, L6, C12 and C13 and a resistive pad consisting of R4, R5 and R6. The output of the resistive pad is applied to the base of driver Q202. The resistive pad lowers the gain of driver Q202. L7 and R8 comprise a stabilizing network in the base circuit of Q202.

Collector voltage to Q202 is applied through collector stabilizing network Z1 and collector feed network L9 and C17.

Collector current for Q202 is metered across tapped manganin resistor R12 at J205 (Driver Current). The reading is taken on the one-Volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

The output of Q202 is applied to the base of Class C Power Amplifier Q203 through a matching network (L9, L10, C16 and C19 through C24) that matches the output impedance of driver Q202 with the input impedance of power amplifier Q203. R9, R10 and L11 comprise a stabilizing network in the base circuit of Q203.

Collector voltage to Q203 is coupled through collector stabilizing network Z2 and collector feed network L12 and C27.

Collector current for Q203 is metered across tapped manganin resistor R13. The reading is taken on the one-Volt scale with the High Sensitivity button pressed, and read as 10 amperes full scale.

Following Q203 is a matching network (L13, C25, C26, C29, C31 and L14) that matches the output of Q203 to the 50-ohm microstrip impedance (W1) to the input of low pass filter. Coupling capacitor C30 couples the output of the PA to the low pass filter. It also provides DC isolation between the transmitter and the antenna.

The PA output is coupled through the low-pass filter to the antenna through antenna transfer relay K1901.

Capacitors C34 through C37 provide ground isolation for positive and negative ground operation.

— WARNING —

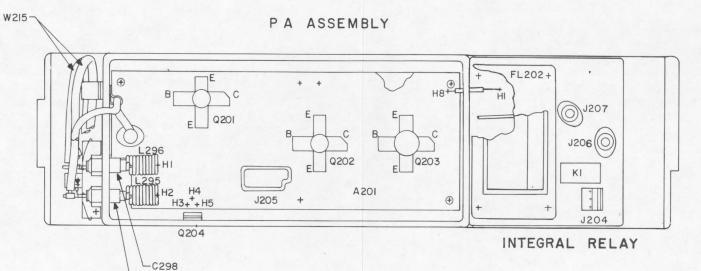
The RF Power Transistors used in the transmitter contain Beryllium Oxide, A TOXIC substance. If the ceramic, or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Use care in replacing transistors of this type.

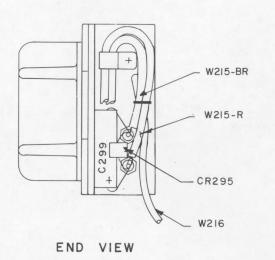
POWER ADJUST CIRCUIT

The power adjust circuit consists of R14 and Q204. R14 controls the base voltage and therefore the conduction of Q204. Q204 is connected in series with the collector feed network for Q201 thereby controlling the drive to driver Q202 and the output power. R14 is adjusted to provide the desired output power over a range of 15 to 50 watts.

GENERAL ELECTRIC COMPANY • MOBILE COMMUNICATIONS DIVISION WORLD HEADQUARTERS • LYNCHBURG, VIRGINIA 24502 U.S.A.

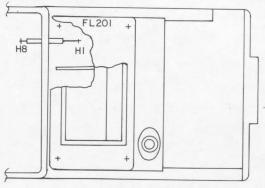






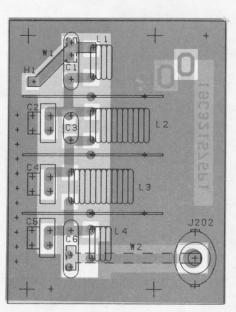
C297

(19C327195, Rev. 4)

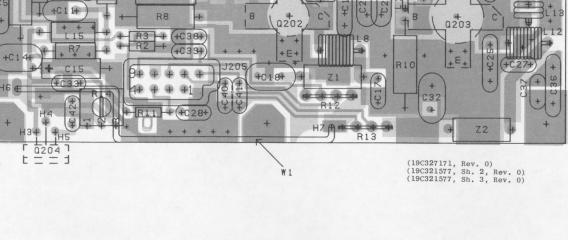


EXTERNAL RELAY

LOW PASS FILTER FL20I (EXTERNAL RELAY)



(19B227405, Rev. 1) (19B226835, Sh. 2, Rev. 0) (19B226835, Sh. 3, Rev. 0)

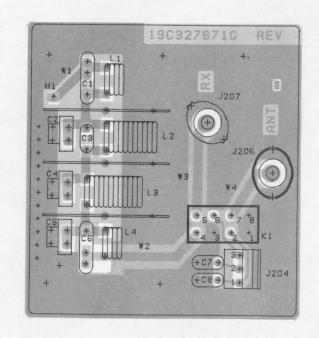


- RUNS ON SOLDER SIDE

- RUNS ON COMPONENT SIDE

RUNS ON BOTH SIDES

LOW PASS FILTER FL 202 (INTEGRAL RELAY)



(19C327917, Sh, 1, Rev. 0) (19B227883, Sh, 1, Rev. 0) (19B227883, Sh. 2, Rev. 0)

OUTLINE DIAGRAM

29.7—50 MHz POWER AMPLIFIER

Issue 4

PARTS LIST LBI30094D

50 WATT POWER AMPLIFIER
1 29.7-36 MHz (L) EXTERNAL RELAY
2 36-42 MHz (M) EXTERNAL RELAY
3 42-50 MHz (H) EXTERNAL RELAY
2 29.7-36 MHz (L) INTEGRAL RELAY
5 36-42 MHz (M) INTEGRAL RELAY
5 42-50 MHz (H) INTEGRAL RELAY

SYMBOL	GE PART NO.	DESCRIPTION
A201		COMPONENT BOARD A201L 19D423257G1 29.7-36 MHz A201M 19D423257G2 36-42 MHz A201H 19D423257G3 42-50 MHz
Cl	19A116655P19	
C2	19A116080P101	RMC Type JF Discap. Polyester: 0.01 \(\mu \text{f} \) \(\psi \) \(\text{TOCW} \).
and C3		
C4	5496267P13	Tantalum: 2.2 µf ±20%, 20 VDCW; sim to Sprague Type 150D.
C5	19A116655P23	Ceramic disc: 3900 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C6	19A700105P36	Mica: 120 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C7L	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C7M	19A700105P44	Mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
С7Н	19A700105P41	Mica: 180 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C8	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
С9	19A116656P100J1	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef
Clor	19A700105P46	-150 PPM. Mica: 270 pf ±5%, 500 VDCW; sim to Electro
Clow	19A700105P46	Motive Type DM15. Mica: 270 pf ±5%, 500 VDCw; sim to Electro
	19A700105P44	Motive Type DM15. Mica: 220 pf ±5%, 500 VDCW; sim to Electro
Cloh		Motive Type DM15. Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro
Cllr	7489162P39	Motive Type DM-15.
C11W	19A700105P46	Motive Type DM15.
C11H	19A700105P44	Motive Type DM15.
C12	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C13L	19A700105P44	Mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C13M	19A700105P44	Mica: 220 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C13H	19A700105P41	Mica: 180 pf ±5%, 500 VDCW; sim to Electro Motive Type DM15.
C14 C15	19A116080P107 5496267P18	Polyester: 0.1 µf ±10%, 50 VDCW. Tantalum: 6.8 µf ±20%, 35 VDCW; sim to Sprague
C16L	19A116656P56J0	Type 150D. Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef
	19A116656P47J0	O PPM. Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef
C16M		O PPM. Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef
C16H	19A116656P39J0	0 PPM. Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to
C17L	19A116655P19	RMC Type JF Discap.
C17M	19A116655P17	RMC Type JF Discap.
C17H	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

	SYMBOL	GE PART NO.	DESCRIPTION
	C18	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.
	C19L	7489162P39	Silver mica: 330 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C19M	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	С19Н	19A700105P44	Mica: 220 pf ±5%, 500 VDCw; sim to Electro Motive Type DM-15.
	C20L	19A116656P56J0	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef 0 PPM.
	C20M	19A116656P47J0	Ceramic disc: 47 pf ±5%, 500 VDCW, temp coef 0 PPM.
	С20Н	19A116656P39J0	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef O PPM.
-	C21L	7489162P39	Silver mica: 330 pf ±5%, 500 VDCw; sim to Electro Motive Type DM-15.
	C21M	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
Ì	C21H	19A700105P46	Mica: 270 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.
	C22L	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C22M	19A700105P46	Mica: 270 pf $\pm 5\%$, 500 VDCW; sim to Electro Motive Type DM-15.
	С22Н	19A7OO1O5P41	Mica: 180 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C23L	7489162P39	Silver mica: 330 pf $\pm 5\%$, 500 VDCW; sim to flectro Motive Type DM-15.
	C23M	19A700105P46	Mica: 270 pf $\pm 5\%$, 500 VDCw; sim to Electro Motive Type DM-15.
ļ	С23Н	19A700105P46	Mica: 270 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C24L	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C24 M	19A700105P46	Mica: 270 pf ±5%, 500 VDCW; sim to Electro Motive Type DM-15.
	С24Н	19A700105P41	Mica: 180 pf \pm 5%, 500 VDCW; sim to Electro Motive Type DM-15.
	C25L	19All6656P150J1	Ceramic disc: 150 pf $\pm 5\%$, 500 VDCw, temp coef -150 PPM.
	C25M	19A116656P100J1	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -150 PPM.
tro	C25H*	19A116656P100J1	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef -150 PPM.
		10411 CC5 CD5 C 10	Earlier than REV A: Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef
	ana.	19A116656P56J0	O PPM. Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef
	C26L	19A116656P150J1	-150 PPM. Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef
	C26M	19A116656P100J1	Ceramic disc: 100 pf ±5%, 500 VDCW, temp coef
	C26H*	198110030710001	-150 PPM. Earlier than REV A:
		19A116656P56J0	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef 0 PPM.
	C27L	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCw; sim to RMC Type JF Discap.
	C27M	19A116655P17	Ceramic disc: 680 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
	С27Н	19All6655P17	Ceramic disc: 680 pf ±20%, 1000 VDCw; sim to RMC Type JF Discap.
	C28	19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
	C29L	19A116679P500J	Mica: 500 pf ±5%, 250 VDCW.
	C29M	19A700015P44	Metallized teflon: 430 pf ±5%, 250 VDCW.
	С29Н	19A700015P12	Metallized teflon: 22 pf ±5%, 250 VDCW.
	C30F	19A700015P38	Metallized teflon: 240 pf ±5%, 250 VDCW.
	C30W	19A700015P37	Metallized teflon: 220 pf ±5%, 250 VDCW. Metallized teflon: 180 pf ±5%, 250 VDCW.
	С30Н	19A700015P35	modelized office, too by Tobi and toom.

cw.	
/DCW; sim to	
im to Electro	
im to Electro	PIOI TO
DCW, temp coef	EXCI
DCW, temp coef	
DCW, temp coef	
/DCw; sim to	
m to Electro	
m to Electro	1
m to Electro	
im to Electro	
im to Electro	
/DCW; sim to Electro	<u> </u>
im to Electro	
im to Electro	
im to Electro	
	i i
im to Electro	
im to Electro	
VDCW, temp coef	l il
VDCW, temp coef	
VDCW, temp coef	i
, -	
VDCW, temp coef	
	<u> </u>
VDCW, temp coef	
000 VDCW;	
00 VDCW;	
00 VDCw;	
000 VDCW;	
oro mes	
, 250 VDCW. 250 VDCW.]
, 250 VDCW.	
, 250 VDCW.	
, 250 VDCW.	
	-

______ J204 DRIVER NOTE I) Q20I Q202 Q203 (SEE NOTE!) A201 * L5 L6 TO RECEIVER PWR. AMPL. L 19D423257 LI L2 3900 未ç₂ .022UF 100 L3 } 上 C6 ↑ I20 8.2 🕽 FL202 INTEGRAL ANTENNA TRANSFER RELAY PL19C327671 __C13 C27 * .022 UF *COMPONENT VALUES AS FOLLOWS **六**C32 (SEE CH COMP IDENT 30-36 MHz 36-42 MHz 42-50 MHz NOTE I) J202 NOTED 1/4 W ₹R2 \$510 FL20I PLI9C32I576 EXTERNAL ANTENNA TRANSFER RELAY 1 2 3 4 5 6 7 8 9 J205 I. 50 OHM MICROSTRIP (PART OF PW BD) 2. Q201, Q202, Q203 & Q204 ARE CALLED FOR ON PL19D423356 L296 L295 3. / INDICATES A-C42 C33 ⊥ INDICATES VEHICLE GROUND FL201,202-C1 68 3.8V FL201,202-C2 91 FL201,202-C3 13 FL201,202-C4 110 FL201,202-C5 100 O C298 C297 FREQUENCY PA ASSEMBLY REV LTR PWR AMPL REV LTR LP FILTER **VOLTAGE READINGS** _ _ _ _ _ 30 - 36 MHz PL19D423356G1 36 - 42 MHz PL19D423356G2 PLI9D423257G1 PL19C321576G1 POWER CONTROL VOLTAGE READINGS ARE TYPICAL READINGS MADE WITH TRANSMITTER KEYED, AND MEASURED WITH A 20,000 OHMS-PER-VOLT METER WITH REFERENCE TO A- AND NOT CHASSIS GROUND. AN RF CHOKE (25-50 MICROHENRYS) IS USED IN THE HOT METER LEAD TO AVOID DETUNING RF CIRCUITS. PL 19C321576G 42 -50 MHz PL19D423356G3 PLI9C32I576G3 Q204 O O O O F30 - 36 MHz PL19D423356G4 PL19D423257G1 . PLI9C32767IGI 3G-42 MHz PLI9D423356G5 42-50 MHz PLI9D423356G6 PL19D423257G2 PL19C327671G2 C299 200 UF IN ORDER TO RETAIN RATED EQUIPMENT F1.190 423257G3 PERFORMANCE, REPLACEMENT OF ANY NOTE: READINGS AT Q204 EMITTER AND IN THE POWER CONTROL CIRCUIT WERE TAKEN WITH THE TRANSMITTER ADJUSTED FOR 40 WATTS OUTPUT. THESE READINGS WILL VARY DEPENDING ON THE SETTING OF POWER ADJUST CONTROL RI4. SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS CR295 6+ +1 SHOWN ON THE PARTS LIST FOR THAT PART. 7+ +2 ALL RESISTORS ARE 1/2 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY 8+ +3 9+ +4 K=1000 OHMS OR MEG=1,000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED J205 SCHEMATIC DIAGRAM DC POWER BY UF = MICROFARADS, INDUCTANCE VALUES
IN MICROHENRYS UNLESS FOLLOWED BY
MH= MILLIHENRYS OR H=HENRYS. INPUT (TOP VIEW) (19R622315, Rev. 1) 29.7—50 MHz POWER AMPLIFIER

LBI30046

SYMBÓL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBO
C3JT	19A116679P500J	Mica: 500 pf ±5%, 250 VDCW.	L15	19A700000P17	Coil, RF: 3.3 µh ±10%, 0.140 ohms DC res max.	C4L	19A700015P30	Teflon/Mica: 110 pf ±5%, 250 VDCW.						JACKS AND RECEPTACLES	
C31M	19A700015P44	Metallized teflon: 430 pf ±5%, 250 VDCW.				C5L	19A700015P29	Teflon/Mica: 100 pf ±5%, 250 VDCw.	LIH	19A12936QP1	Coil.	J204	19A116659P55	Connector, printed wiring: 3 contacts; sim to	Q201*
C31H	19A700015P42	Metallized teflon: 360 pf ±5%, 250 VDCW.	n2.	101700110715		C6L	19A116656P68J1	Ceramic disc: 68 pf ±5%, 500 VDCW, temp coef	L2H	19A129360P2	Coil.			Molex 09-65-1031.	Q201L and
C32	19A116080P107	Polyester: 0.1 µf ±10%, 50 VDCW.	R1L R1M	19A700113P15 3R77P200J	Composition: 10 ohms ±5%, 1/2 w. Composition: 20 ohms ±5%, 1/2 w.			100 114.	ТЗН	19A129360P3	Coil.	J206 and	19A130924G1	Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.	Q201M
C33	19A116080P103	Polyester: 0.022 µf ±10%, 50 VDCW.	RlH	3R77P200J	Composition: 20 ohms ±5%, 1/2 w.			JACKS AND RECEPTACLES	LAH	19A129360P1	Coil.	J207		DELAYO	Q201H*
C34	19A116655P23	Ceramic disc: 3900 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	R2	3R152P511J	Composition: 510 ohms ±5%, 1/4 w.	J202	19A130924G1	Connector, receptacle: jack type; sim to Cinch 14H11613.				K1	19A700061P1	Hermetic sealed: 180 to 341 ohms coil res, 8-16.3	Q202
C35	19A116080P103	Polyester: 0.022 µf ±10%, 50 VDCw.	R3	19A700106P77	Composition: 3.9K ohms ±5%, 1/4 w.				wl		(Part of printed wiring board 19C321575P1).	. A.	19470000171	VDC; sim to GE 3SAV1760A2, CP Clare HFW-1201558, or Potter-Brumfield HCM6160.	Q203
C36	19A116655P23	Ceramic disc: 3900 pf ±20%, 1000 VDCW; sim to	R4L	19A700112P9	Composition: 5.6 ohms ±5%, 1 w.			INDUCTORS	and W2					or rotter branches nonesto.	Q204
	10.11.000.00100	RMC Type JF Discap. Polyester: 0.022 µf ±10%, 50 VDCW.	R4M	19A700112P1	Composition: 2.7 ohms ±5%, 1 w.	r1r	19A129360P6	Coil.							.
C37	19A116080P103 19A116655P19	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to	R4H	7147161P22	Composition: 1.2 ohms ±5%, 1/2 w.	L2L L3L	19A129360P7 19A129360P8	Coil.	FL202L			T1W	19A129360P4	Coil.	W214
C38 thru C42	194110033413	RMC Type JF Discap.	R5L	19A700112P9	Composition: 5.6 ohms ±5%, 1 w.	IAL	19A129360P6	Coil.	F112021		LOW PASS FILTER (INTEGRAL RELAY)	L2M	19A129360P3	Coil.	W215
C42		DIODES AND RECTIFIERS	R5M	19A700112P1	Composition: 2.7 ohms ±5%, 1 w.	LALL	194129300F0				19C327671G1 29.7-36 MHz	T3W	19A129360P5	Coil.	W216
CR1	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R5H	7147161P22	Composition: 1.2 ohms ±5%, 1/2 w.							LAM	19A129360P4	Coil.	.
			R6L	19A700112P9	Composition: 56 ohms ±5%, 1 w.	W1 and		(Part of printed wiring board 19C321575P1).	ClL	19A116656P68J1	Ceramic disc: 68 pf ±5%, 500 VDCw, temp coef -150 PPM.				.
		JACKS AND RECEPTACLES	R6M	19A700112P1	Composition: 2.7 ohms ±5%, 1 w.	w2			C2L	19A700015P28	Metallized teflon: 91 pf ±5%, 250 VDCw.	W1	1	(Part of printed wiring board 19C327672P1).	
J201	19A130924G1	Connector, receptacle: jack type; sim to Cinch 14H11613.	R6H	7147161P22	Composition: 1.2 ohms ±5%, 1/2 w.				C3L	19A116656P13J1	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef	thru W4	1		,
J205	19B219374G1	Connector: 9 contacts.	R7	19A700113P15	Composition: 10 ohms ±5%, 1/2 w.		ļ	LOW PASS FILTER			-150 PPM.				.
		INDUCTORS	R8	3R78P200J	Composition: 20 ohms ±5%, 1 w.			(EXTERNAL RELAY) 19C321576G2 36-42 MHz	C4L	19A700015P30	Metallized teflon: 110 pf ±5%, 250 VDCW.	FL202H		LOW PASS FILTER	i l
			R9	19A700113P1	Composition: 2.7 ohms ±5%, 1/2 w.				C5L	19A700015P29	Teflon/Mica: 100 pf ±5%, 250 VDCw.	FIZOZII		(INTEGRAL RELAY) 19C327671G3 42-50 MHz	.
LlL	19A129347P1	Coil.	RlOL	19A700112P15	Composition: 10 ohms ±5%, 1 w.		1		CGT	19A116656P68J1	Ceramic disc: 68 pf ±5%, 500 VDCW, temp coef -150 PPM.			10002107140 12 00 222	,
Llm	19A129347P3	Coil.	R10M	3R78P200J	Composition: 20 ohms ±5%, 1 w.	ClW	19A116656P56J1	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef -150 PPM.	C7	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to			CAPACITORS	4
TIH	19A129347P4	Coil.	R10H	3R78P200J	Composition: 20 ohms ±5%, 1 w.	C2M	19A700015P25	Metallized teflon: 68 pf ±5%, 250 VDCW.	and C8		RMC Type JF Discap.	C1H	19A116656P56J1	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef -150 PPM.	1
1.21.	19A129354P4 19A129352P8	Coil.	R11	3R152P274J	Composition: 270K ohms ±5%, 1/4 w.	СЗЖ	19A116656P12J1	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef	,		JACKS AND RECEPTACLES	С2Н	19A700015P23	Metallized teflon: 56 pf ±5%, 250 VDCW.	ı İ
L2M L2H	19A129352P7	Coil.	R12 and	19C32O212P2	Shunt resistor.	914	19A700015P28	-150 PPM. Metallized teflon: 91 pf ±5%, 250 VDCw.	J204	19A116659P55	Connector, printed wiring: 3 contacts; sim to	СЗН	19A116656P10J1	Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef	.
128	198129352F1		R13			C4M	19A700015P28	metallized tellon. 91 pl 13%, 230 vbc			Molex 09-65-1031.			-150 PPM.	<i>i</i> 1
															<i>i</i>
,															, I
1.3	19A700000P122	Coil, RF: 8.2 µh ±10%, 0.22 ohms DC res max.	R14	19All6559Pl02	Variable, cermet: 5K ohms ±20%, .5 w; sim to	C5M	19A700015P27	Metallized teflon: 82 pf ±5%, 250 VDCW.	J206 and	19A130924G1	Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.	C4H	19A700015P27	Metallized teflon: 82 pf ±5%, 250 VDCW.	<i>i</i>
LA	19A700000P6	Coil, RF: 0.33 µh ±20%, 0.065 ohms DC res max.			CTS Series 360.	C6M	19A116656P56J1	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef -150 PPM.	J207		to their milities.	С5Н	19A700015P26	Metallized teflon: 75 pf ±5%, 250 VDCW.	.
L5L	19A129351P3	Coil.									RELAYS	С6Н	19A116656P51J1	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef	ı I
L5M	19A129351P2	Coil.	Wl	19B226909G2	Jumper,			JACKS AND RECEPTACLES	K 1	19A700061P1	Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CP Clare HFW-1201558,		10.11.ccr5.poo	-150 PPM. Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to	ı
L5H	19A129351P2	Coil.				J202	19A130924G1	Connector, receptacle: jack type; sim to Cinch 14H11613.			or Potter-Brumfield HCM6160.	C7 and	19A116655P20	RMC Type JF Discap.	<u> </u>
TeT	19A129352P1	Coil.	۷1		FILTER ASSEMBLY							C8		JACKS AND RECEPTACLES	1
L6M	19A129352P3	Coil.	and		19B219649G1			INDUCTORS	LlL	19A129360P6	Coil.	J204	194116659055	Connector, printed wiring: 3 contacts; sim to	l
L6H	19A129348P2	Coil.				LlM	19A129360P4	Coil.	L2L	19A129360P7	Coil.	3204	154110035133	Molex 09-65-1031.	1
1.7	19A700000P122	Coil, RF: 8.2 µh ±10%, 0.22 ohms DC res max.	μ1	19A129346G2	Coil.	1.2M	19A129360P3	Coil.	L3L	19A129360P8	Coil.	J206 and	19A130924G1	Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.	1
T8T	19A129349P1	Coil.				L3M	19A129360P5	Coil.	LAL	19A129360P6	Coil.	J207	,		Chan
L8M	19A129349P2	Coil.			RESISTORS	LAM	19A129360P4	Coil.							Chang Letter previo
TSH	19A129349P2	Coil.	R1	3R78P100K	Composition: 10 ohms ±10%, 1 w.					ļ		K 1	19A700061P1	Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CP Clare HFw-1201558,	previo
rar	19A129352P4	Coil.				W1		(Part of printed wiring board 19C321575P1).	W1 thru		(Part of printed wiring board 19C327672P1).			or Potter-Brumfield HCM6160.	REV.
L9M	19A129352P4	Coil.	C297	19A116708P1	Ceramic, feed-thru: 0.01 µf +100% -0%, 500 VDCW;	and w2			W4	ļ					
L9H	19A129352P2	Coil.	and C298		sim to Erie Style 327.	FL201H		LOW PASS FILTER				LlH	19A129360P1	Coil.	
r10r	19A129359P1	Coil,	C299	19A115680P10	Electrolytic: 200 µf +150% -10%, 18 VDCW; sim	FLZUIR		(EXTERNAL RELAY) 19C321576G3 42-50 MHz	FL202M		LOW PASS FILTER (INTEGRAL RELAY)	L2H	19A129360P2	Coil.	1
T10M	19A129357P1	Coil.	İ		to Mallory Type TTX.						19C327671G2 36-42 MHz	тзн	19A129360P3	Coil.	
L10H	19A129357P2	Coil.			DIODES AND RECTIFIERS				1			LAH	19A129360P1	Coil.	
Lll	19A700000P122	Coil, RF: 8.2 µh ±10%, 0.22 ohms DC res max.	CR295	19A116783P1	Rectifier, silicon: 100 VDC blocking, 6 amps.	CIH	19A116656P51J1	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef -150 PPM.	CIM	19A116656P56J1	Ceramic disc: 56 pf ±5%, 500 VDCw, temp coef	İ	1	CABLES	
Ll2L	19A129349P1	Coil.				С2Н	19A700015P23	Metallized teflon: 56 pf ±5%, 250 VDCW.		15/12/00007 0007	-150 PPM.			(Part of printed wiring board 19C327672P1).	
L12M	19A129349P2	Coil.	FL201L		LOW PASS FILTER	СЗН	19A116656P10J1	Ceramic disc: 10 pf ±0.5 pf, 500 VDCW, temp coef	C2M	19A700015P25	Teflon/Mica: 68 pf ±5%, 250 VDCW.	wl thru		(Part of princed willing board 10001.0151-17)	ĺ
L12H	19A129349P2	Coil.			(EXTERNAL RELAY) 19C321576G1 29.7-36 MHz			-150 PPM.	СЗМ	19A116656P12J1	Ceramic disc: 12 pf ±5%, 500 VDCW, temp coef -150 PPM.	₩4			
L13M	19A129358P2 19A129355P3	Coil.				C4H	19A700015P27	Teflon/Mica: 82 pf ±5%, 250 VDCW.	C4M	19A700015P28	Metallized teflon: 91 pf ±5%, 250 VDCw.				1
1	19A129351P4	Coil.				C5H	19A700015P26	Teflon/Mica: 75 pf ±5%, 250 VDCW.	C5M	19A700015P27	Metallized teflon; 82 pf ±5%, 250 VDCW.	L295	19A130640G1	Coil.	
L13H L14L	19A129355P5	Coil.	CIL	19A116656P68J1	Ceramic disc: 68 pf ±5%, 500 VDCW, temp coef -150 PPM.	С6Н	19A116656P51J1	Ceramic disc: 51 pf ±5%, 500 VDCW, temp coef -150 PPM.	C6M	19A116656P56J1	Ceramic disc: 56 pf ±5%, 500 VDCW, temp coef	1.296			1
L14M	19A129355P4	Coil.	C2L	19A700015P28	Teflon: 91 pf ±5%, 250 VDCw.			TAGER AND DEGERMAN ES	1 1		-150 PPM.				1
L14H	19A129352P10	Coil.	C3T	19A116656P13J1	Ceramic disc: 13 pf ±5%, 500 VDCW, temp coef		10410000457	JACKS AND RECEPTACLES	C7 and	19A116655P20	Ceramic disc: 1000 pf ±10%, 1000 VDCW; sim to RMC Type JF Discap.				1
					-150 PPM.	J202	19A130924G1	Connector, receptacle: jack type; sim to Cinch 14H11613.	C8						
							1								1
	•	· · · · · · · · · · · · · · · · · · ·	ļ						-	•		' <u>L</u>	<u> </u>		Y

SYMBOL	GE PART NO.	DESCRIPTION
Q201*	19A116839P1	Silicon, NPN. Deleted by REV A.
Q201L and Q201M	19A116839P1	Silicon, NPN.
Q201H*	19A116965Pl	Silicon, NPN. Added by REV A.
Q202	19A116839P2	Silicon, NPN.
Q203	19A116839P3	Silicon, NPN.
Q204	19A116742P1	Silicon, NPN.
W214	19A130607G2	Cable, RF: approx 1 foot long.
W215	19B227058Gl	Cable: approx 1 foot long.
W216	19A130909G1	Cable, RF: approx 7-1/2 inches long.
		MISCELLANEOUS
	19C321591G1	Heat sink, casting.
	19C321693P1	Insulator. (Located under A201).
	19A134016P1	Insulator, bushing. (Used with Q204).
	19A116023P1	Insulator, plate. (Used with Q204).
	5492178P2	Washer, spring tension: sim to Wallace Barnes 375-20. (Used with Q201-Q203).
	N207P15C6	Nut, hex: No. 8-32. (Used with Q201-Q203).
	N207P16C6	Nut, hex: No. 10-32. (Used with Q201-Q203).
	19129434P1	Washer: fiber. (Used with L295, L296).
	4029851P6	Clip loop. (Secures w215).
	19B226952G1	P.A. Cover.
	19D416275P3	Filter housing.
	19B201074P312	Tap screw, Phillips POZIDRIY®: No. 6-32 x 3/4. (Secures FL201).
	19B201074P305	Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16. (Secures A201 board).
	7139898P3	Nut, hex: 1/4-28. (Secures C297 & C298).

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - PA Board 19D423257G3 & PA Assembly 19D423356G3, G6

To improve power output at high end of frequency range (50 MHz).
Changed Q201, C25H and C26H.